

**Dual N-Ch MOSFET** 

### **General Description**

The WSP6946 is the highest performance trench N-ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSP6946 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

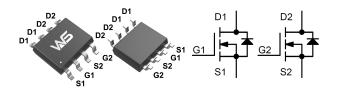
## **Product Summery**

BVDSS	RDSON	ID
60V	<b>33m</b> Ω	6.5A

#### Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

### **SOP-8 Pin Configuration**



# **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	60	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	6.5	А
I <sub>D</sub> @T <sub>C</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	4.5	А
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	24	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	12	mJ
I <sub>AS</sub>	Avalanche Current	16	А
P <sub>D</sub> @T <sub>A</sub> =25℃	Total Power Dissipation <sup>4</sup>	2.5	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>0JA</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		90	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		50	°C/W



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# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	60			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\!\mathrm{C}$ , I_D=1mA		0.044		V/℃
Б	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =6.3A		33	45	
R <sub>DS(ON)</sub>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =4A		37	50	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.0	2.0	3.0	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	──V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-4.8		mV/℃
	Drain Source Lookage Current	V <sub>DS</sub> =48V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =48V , $V_{GS}$ =0V , T <sub>J</sub> =55 $^{\circ}$ C			5	uA uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =4A		28.3		S
R <sub>g</sub>	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.5	5	Ω
Qg	Total Gate Charge (10V)			14	20	
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =48V , V <sub>GS</sub> =10V , I <sub>D</sub> =6.3A		2.6		nC
Q <sub>gd</sub>	Gate-Drain Charge			2.2		
T <sub>d(on)</sub>	Turn-On Delay Time			8	15	
Tr	Rise Time	$V_{DD}$ =30V , $V_{GEN}$ =10V , $R_{G}$ =6 $\Omega$		6	11	ns
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =4A ,R∟=30Ω		23	42	
T <sub>f</sub>	Fall Time			6	11	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		670	940	
Coss	Output Capacitance			70	91	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			35	64	]

### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy $^5$	$V_{DD}$ =25V , L=0.1mH , I <sub>AS</sub> =12A	10			mJ

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>				2.5	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	$V_G = V_D = 0V$ , Force Current			24	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1.1	V
trr	Reverse Recovery Time			20		nS
Q <sub>rr</sub>	Reverse Recovery Charge	l⊧=6.3A , dl/dt=100A/μs , Tյ=25℃		18		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH, I<sub>AS</sub>=12A

4.The power dissipation is limited by 150  $^\circ\!\!\!\mathrm{C}$  junction temperature

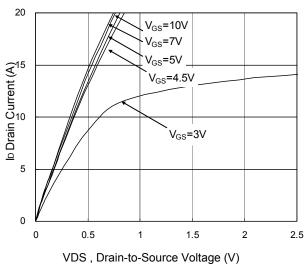
5. The Min. value is 100% EAS tested guarantee.

6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

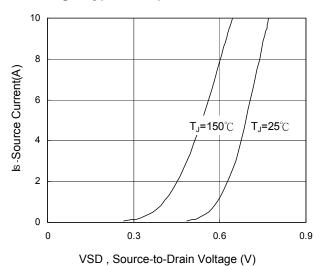


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**Fig.1 Typical Output Characteristics** 





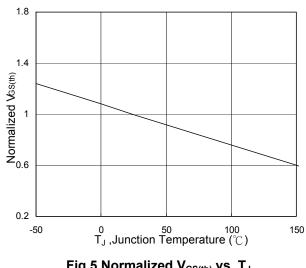


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

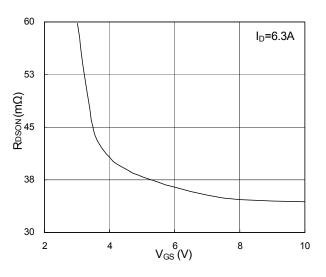


Fig.2 On-Resistance vs. Gate-Source

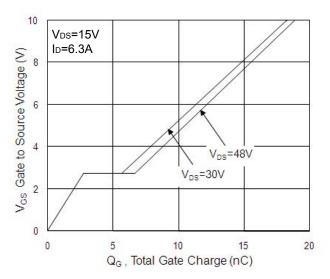


Fig.4 Gate-Charge Characteristics

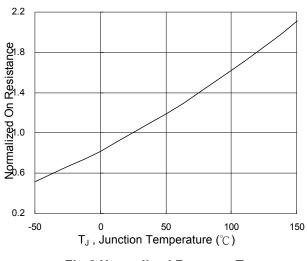
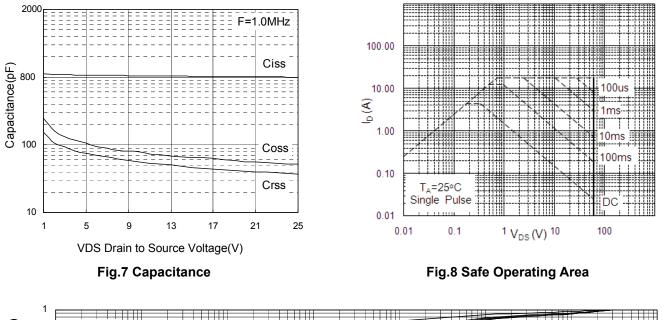
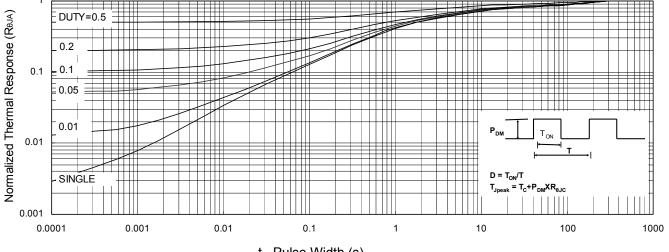


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>



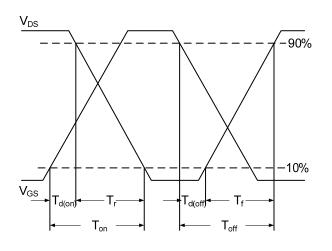
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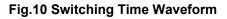




t, Pulse Width (s)







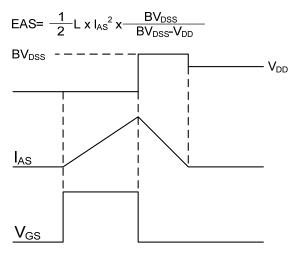


Fig.11 Unclamped Inductive Switching Waveform



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